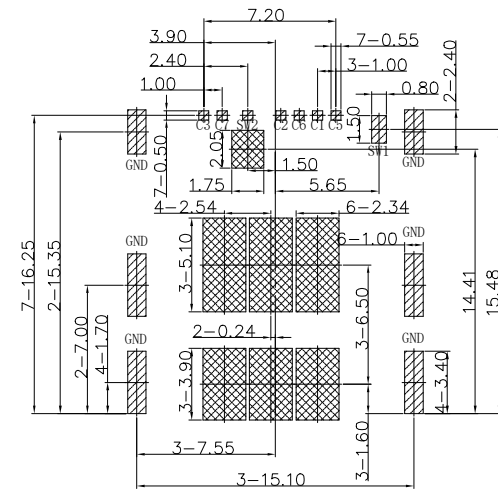
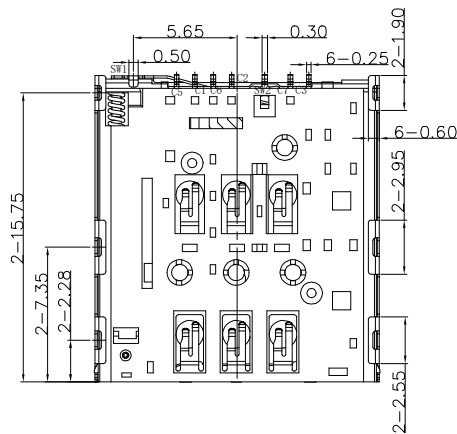
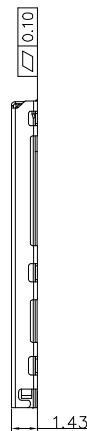




RECOMMENDED PCB LAYOUT

TOLERANCE: ± 0.05

SMT SOLDER AREA

COPPER RESTRICTED AREA

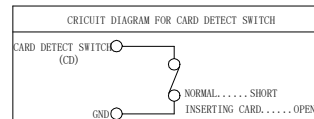
1. TOUCH AREA OF CONTACT TIPS NO ELECTRICAL FUNCTION
2. NO FIRST PCB LAYOUT CIRCUITS IN THE AREA

Notes:

1. Material:
Housing: High Temperature Thermoplastic
Terminal: Copper Alloy
Shell: Stainless Steel
2. Plating:
Terminal: 50u" Ni Underplated Overall
Contact Area: Refer The Part Number
G/F Plated On Solder Area
Shell: 30u" Ni Underplated Overall
3. Technical Speciality:
Rated Voltage: 30V
Current Rating: 0.5A
Insulation Resistance: 1000M Ω Min.
Contact Resistance: 100m Ω Max.
Withstanding Voltage: 500V DC For 1 Minutes.
Operating Temperature: -40°C ~ +75°C Humidity 80% R.H Max.
4. PRODUCT PART NUMBER DESCRIPTION:
10174352-0 0 0 X X LF

PACKAGING

- 1: TAPE & REEL
- PLATING OPTION (CONTACT AREA)
- 1: GOLD FLASH



PIN/NO	ASSIGNMENT
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O
SW1	Detect Lever/GND
SW2	Detect Switch

mat'l. code				surface	tolerance	projection	product family	
ISO 1302				ISO 406	ISO 1101			
ltr	ecn no	dr	date	tolerances	unless otherwise	specified	title	
A	-	TY	04/09/24	angles	.00±0.35		SIM CARD CONNECTOR	
				linear	.00±0.25		SMT TYPE	
				0°±1°	.000±0.15	scale 1:1		
				dr	TY.Tang	04/09/24	dwg no	
				engr	TY.Tang	04/09/24	sheet 1 of 1	
				chr	LQ.Lei	04/09/24	10174352	
				appd	Tim.Yao	04/09/24	A3	
sheet index				revision	1		type Product Customer Drawing	
sheet				revision	1			